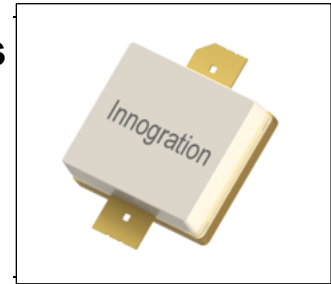


## 300W/500W, 50/65V High Power RF LDMOS FETs



### Description

The ITEV01500A2C is a 50V 300-watt capable, high performance, highly rugged, unmatched, single ended LDMOS FET, designed for commercial and industrial applications with frequencies HF to 200MHz, in new generation highly cost effective open cavity package. It is featured by single ended configuration for high power and high ruggedness, suitable for Industrial, Scientific and Medical application

- Typical performance(on Innogrations test board with device soldered)

Signal: CW , Vgs=3.45V, Vds=50V, Idq=200mA

Freq (MHz)	Pin (dBm)	Pout (dBm)	Pout (W)	Ids (A)	Gain (dB)	Eff (%)	2 <sup>nd</sup> harmonic (dBc)
40.68	35	55	320	8.1	20	80	-25

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large PosiTJVe and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 136-174MHz (Commercial ground communication)
- Laser Exciter
- Synchrotron
- MRI
- Plasma generator
- Weather Radar

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	+185	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+65	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T <sub>j</sub>	+225	°C

**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case T <sub>c</sub> = 85°C, T <sub>j</sub> =200°C, DC test	R <sub>θJC</sub>	0.35	°C/W

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

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**Table 4. Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics (per half section)</b>					
Drain-Source Voltage $V_{GS}=0, I_{DS}=1.0\text{mA}$	$V_{(BR)DSS}$		185		V
Zero Gate Voltage Drain Leakage Current $(V_{DS} = 75\text{V}, V_{GS} = 0\text{V})$	$I_{DSS}$	—	—	1	$\mu\text{A}$
Zero Gate Voltage Drain Leakage Current $(V_{DS} = 50\text{V}, V_{GS} = 0\text{V})$	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate--Source Leakage Current $(V_{GS} = 10\text{V}, V_{DS} = 0\text{V})$	$I_{GSS}$	—	—	1	$\mu\text{A}$
Gate Threshold Voltage $(V_{DS} = 50\text{V}, I_D = 600\text{ }\mu\text{A})$	$V_{GS(th)}$	—	2.65	—	V
Gate Quiescent Voltage $(V_{DD} = 50\text{V}, I_D = 200\text{mA}, \text{Measured in Functional Test})$	$V_{GS(Q)}$	—	3.4	—	V
<b>Load Mismatch (In Innogration Test Fixture, 50 ohm system):</b> $V_{DD} = 50\text{Vdc}, I_{DQ} = 100\text{mA}, f = 100\text{MHz}, \text{pulse width: } 100\mu\text{s}, \text{duty cycle: } 10\%$					
Load 65:1 All phase angles, at 300W Pulsed CW Output Power	No Device Degradation				

## 40.68MHz

### TYPICAL CHARACTERISTICS

Figure 1: CW Gain and Power Efficiency as a Function of Pout at 40.68MHz

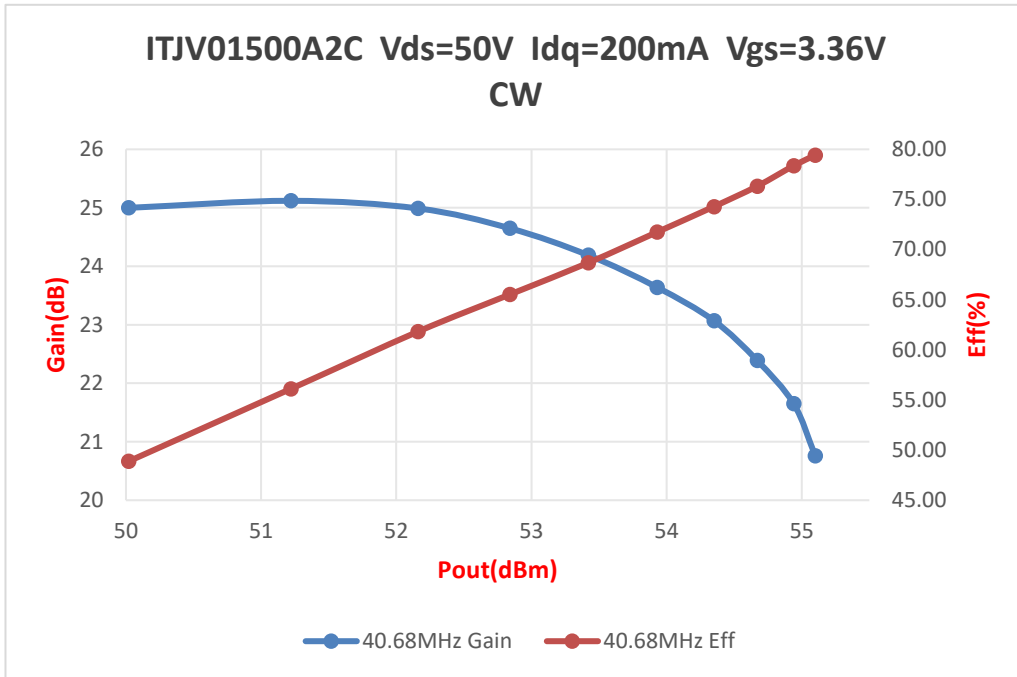
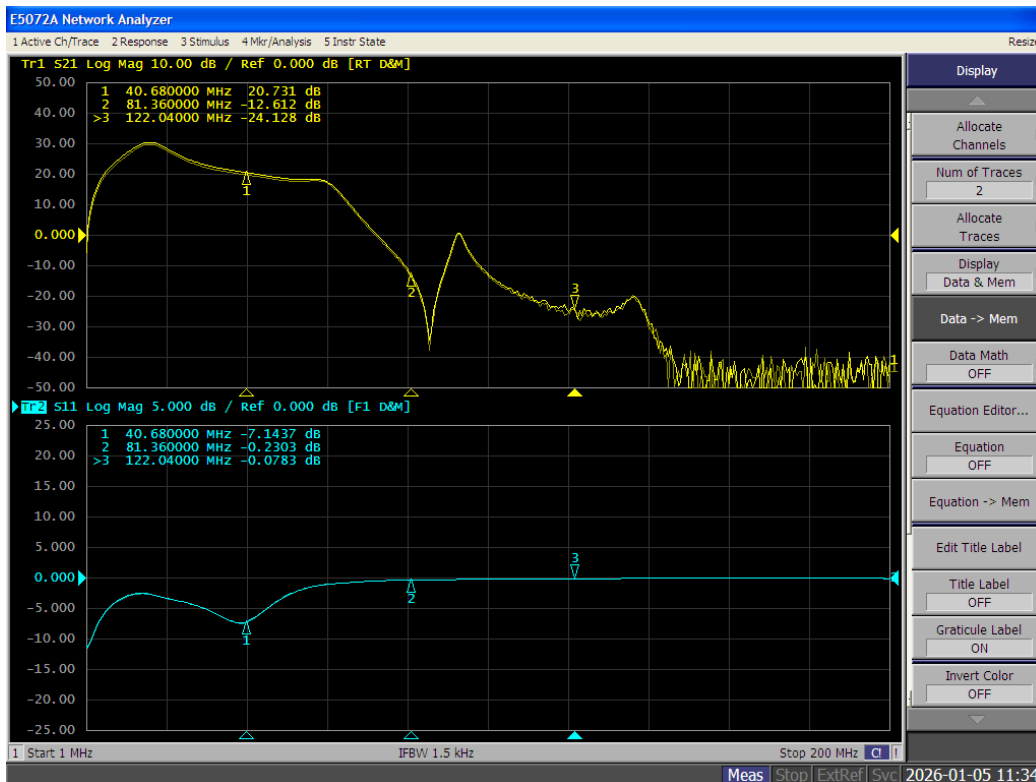


Figure 2: Network analyzer output S11/S21



## Reference Circuit of Test Fixture Assembly Diagram

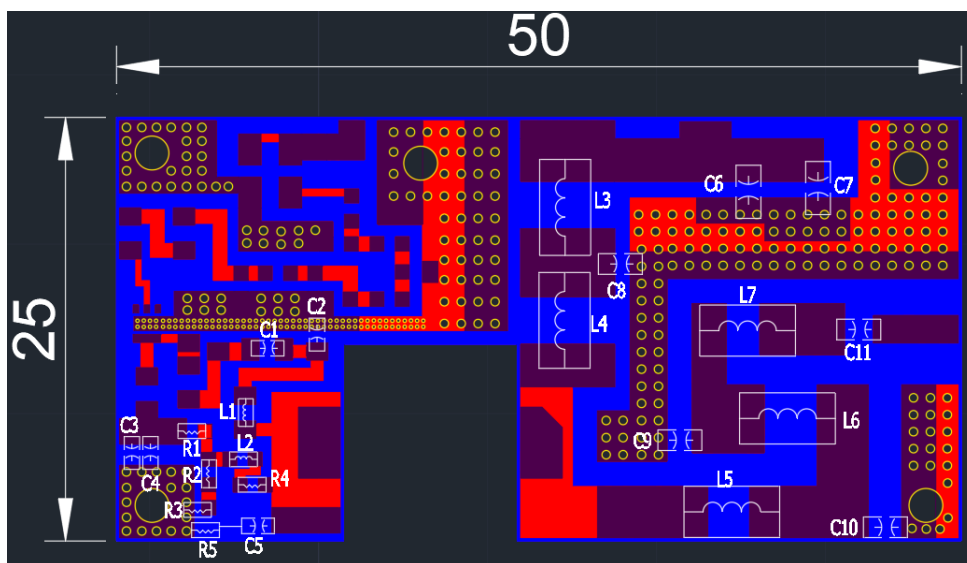
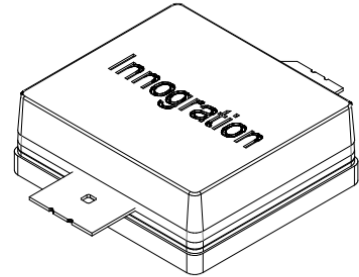
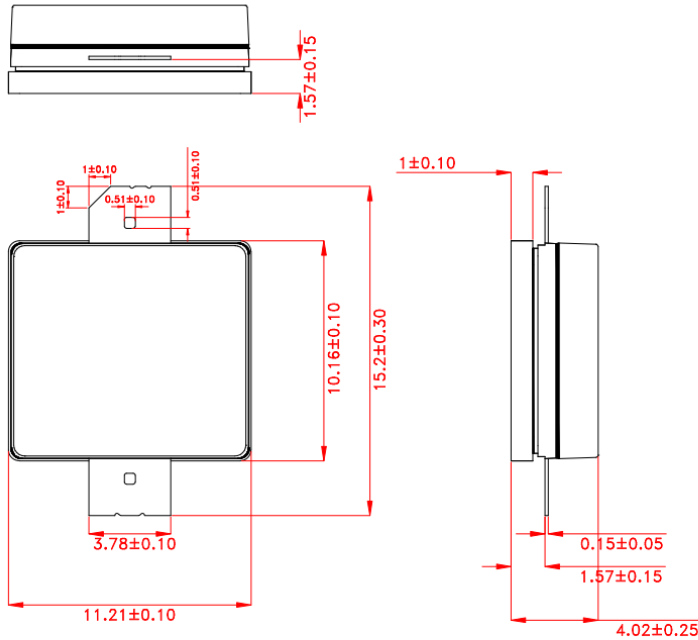


Table 5. Test Circuit Component Designations and Values

C1,C4	10nF/0805	/
C2	120pF/MQ301111	
C3	1uF/0805	
C5,C7	10uF/1210	
C6,C11	1000pF/MQ301111	
C8	82pF/MQ301111	
C9	200pF/MQ301111	
C10	75pF/MQ301111	
R1	3000Ω/0603	
R2	6200Ω/0603	
R3	0.1Ω/0603	
R4	220Ω/0805	
R5	51Ω/0805	
L1	120nH/0805	
L2	82nH/0805	
L3,L4	2mm wire, 6 turns, $\phi = 5\text{mm}$	DIY
L5	2mm wire, 3 turns, $\phi = 5\text{mm}$	DIY
L6	2mm wire, 4 turns, $\phi = 5\text{mm}$	DIY
L7	2mm wire, 3 turns, $\phi = 5\text{mm}$	DIY

## Package Dimensions (Unit:mm)



Unit:mm

Tolerance  $\pm 0.10$ mm, Except as Noted.

## Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2026/1/5	Rev 1.0	Advanced Datasheet Creation

Application data based on SJJ-26-01

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